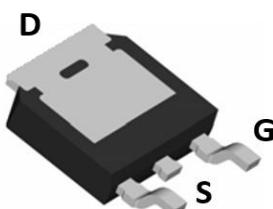
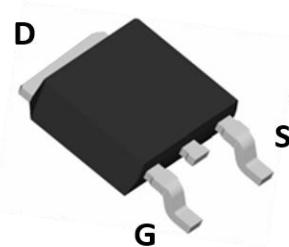
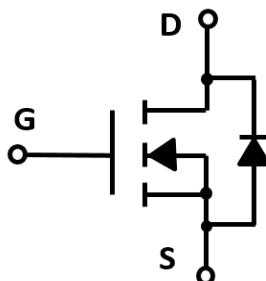


**N-Channel Enhancement Mode Field Effect Transistor****TO-252****Product Summary**

- $V_{DS}$  100V
- $I_D$  15A
- $R_{DS(ON)}$  (at  $V_{GS}=10V$ ) <110 mohm
- $R_{DS(ON)}$  (at  $V_{GS}=4.5V$ ) <120 mohm
- 100% UIS Tested
- 100%  $\nabla V_{DS}$  Tested

**General Description**

- Trench Power MV MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low  $R_{DS(ON)}$

**Applications**

- DC-DC Converters
- Power management functions

**■ Absolute Maximum Ratings ( $T_A=25^\circ C$  unless otherwise noted)**

Parameter		Symbol	Limit	Unit
Drain-source Voltage		$V_{DS}$	100	V
Gate-source Voltage		$V_{GS}$	$\pm 20$	V
Drain Current	$T_c=25^\circ C$	$I_D$	15	A
	$T_c=100^\circ C$		10.5	
Pulsed Drain Current <sup>A</sup>		$I_{DM}$	60	A
Single Pulse Avalanche Energy		$E_{AS}$	9	mJ
Total Power Dissipation	$T_c=25^\circ C$	$P_D$	45	W
	$T_c=100^\circ C$		22.5	
Thermal Resistance Junction-to-Case <sup>B</sup>		$R_{eJC}$	3.3	$^\circ C/W$
Junction and Storage Temperature Range		$T_J, T_{STG}$	-55~+175	$^\circ C$

**■ Ordering Information (Example)**

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJD15N10A	F1	YJD15N10A	2500	2500	25000	13" reel



# YJD15N10A

**■ Electrical Characteristics ( $T_A=25^\circ\text{C}$  unless otherwise noted)**

Parameter	Symbol	Conditions		Min	Typ	Max	Units
<b>Static Parameter</b>							
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$		100			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}}=100\text{V}, V_{\text{GS}}=0\text{V}$	$T_J=25^\circ\text{C}$			1	$\mu\text{A}$
			$T_J=55^\circ\text{C}$			5	
Gate-Body Leakage Current	$I_{\text{GSS}}$	$V_{\text{GS}}= \pm 20\text{V}, V_{\text{DS}}=0\text{V}$				$\pm 100$	nA
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$		1	1.8	2.5	V
Static Drain-Source On-Resistance	$R_{\text{DS(ON)}}$	$V_{\text{GS}}= 10\text{V}, I_{\text{D}}=12\text{A}$			95	110	$\text{m}\Omega$
		$V_{\text{GS}}= 4.5\text{V}, I_{\text{D}}=8\text{A}$			100	120	
Diode Forward Voltage	$V_{\text{SD}}$	$I_{\text{S}}=15\text{A}, V_{\text{GS}}=0\text{V}$			0.8	1.2	V
Maximum Body-Diode Continuous Current	$I_{\text{S}}$					15	A
<b>Dynamic Parameters</b>							
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}}=50\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$			785		$\text{pF}$
Output Capacitance	$C_{\text{oss}}$				38		
Reverse Transfer Capacitance	$C_{\text{rss}}$				30		
<b>Switching Parameters</b>							
Total Gate Charge	$Q_{\text{g}}$	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=50\text{V}, I_{\text{D}}=10\text{A}$			16		$\text{nC}$
Gate-Source Charge	$Q_{\text{gs}}$				2.5		
Gate-Drain Charge	$Q_{\text{gd}}$				2.6		
Turn-on Delay Time	$t_{\text{D(on)}}$	$V_{\text{GS}}=10\text{V}, V_{\text{DD}}=50\text{V}, R_{\text{L}}=6.4\Omega, R_{\text{GEN}}=3\Omega$			5		$\text{ns}$
Turn-on Rise Time	$t_{\text{r}}$				40		
Turn-off Delay Time	$t_{\text{D(off)}}$				20		
Turn-off fall Time	$t_{\text{f}}$				7		

A. Pulse Test: Pulse Width $\leqslant 300\text{us}$ , Duty cycle  $\leqslant 2\%$ .

B.  $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta JC}$  is guaranteed by design, while  $R_{\theta JA}$  is determined by the board design. The maximum rating presented here is based on mounting on a 1 in 2 pad of 2oz copper.



## ■ Typical Performance Characteristics

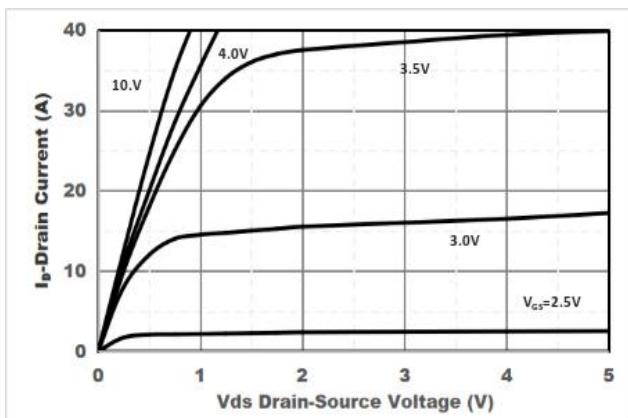


Figure1. Output Characteristics

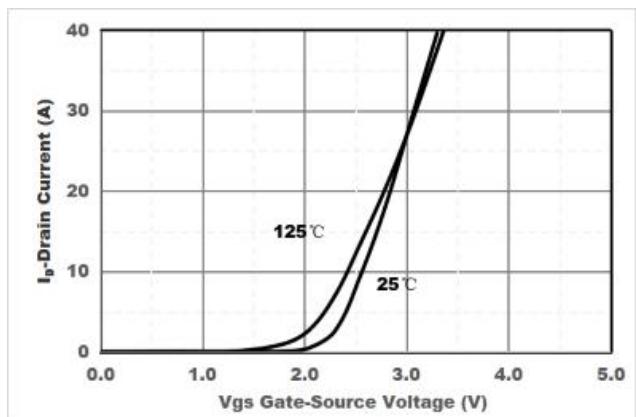


Figure2. Transfer Characteristics

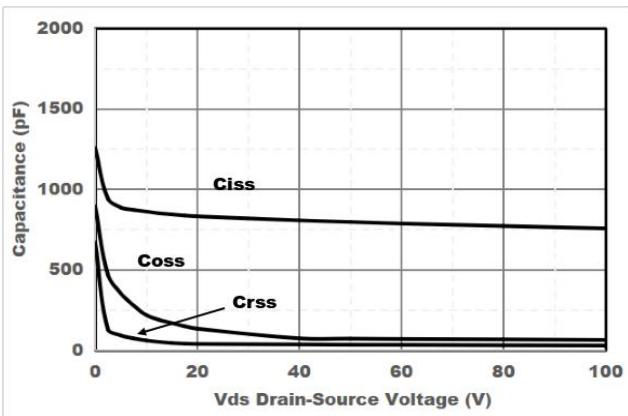


Figure3. Capacitance Characteristics

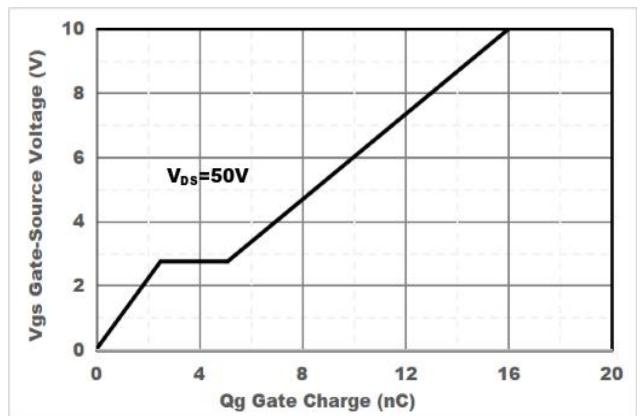


Figure4. Gate Charge

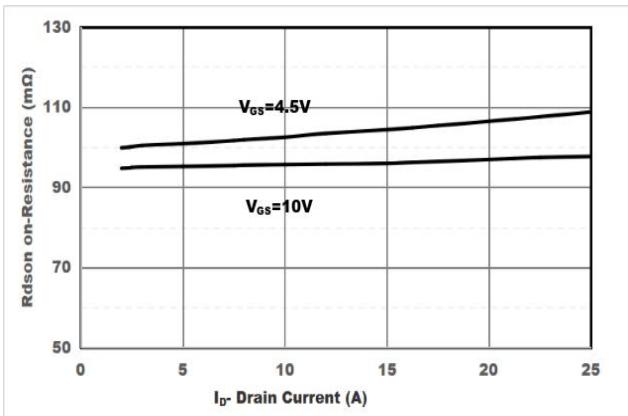


Figure5. Drain-Source on Resistance

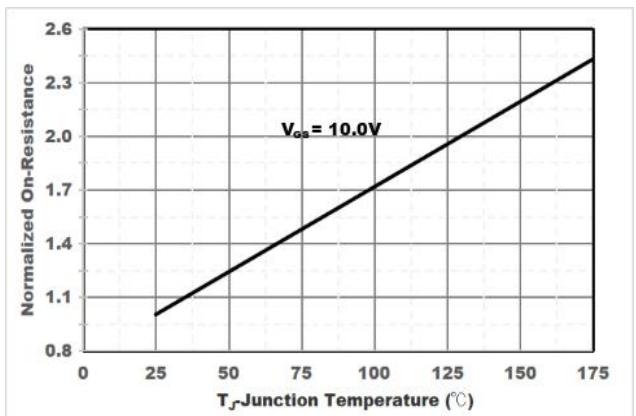


Figure6. Drain-Source on Resistance

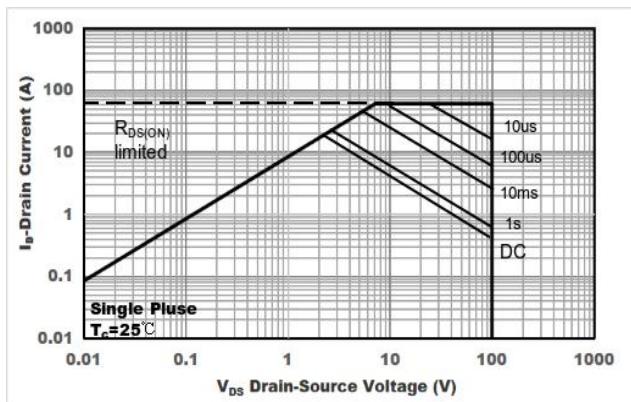


Figure7. Safe Operation Area

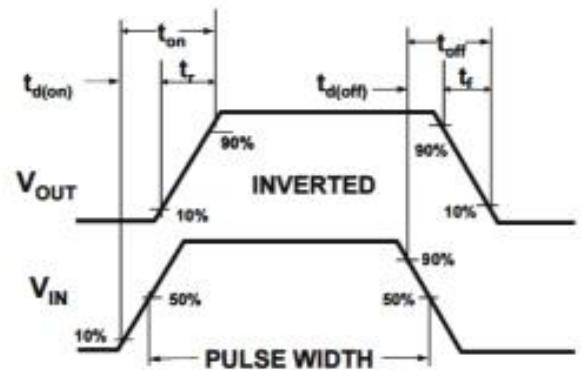
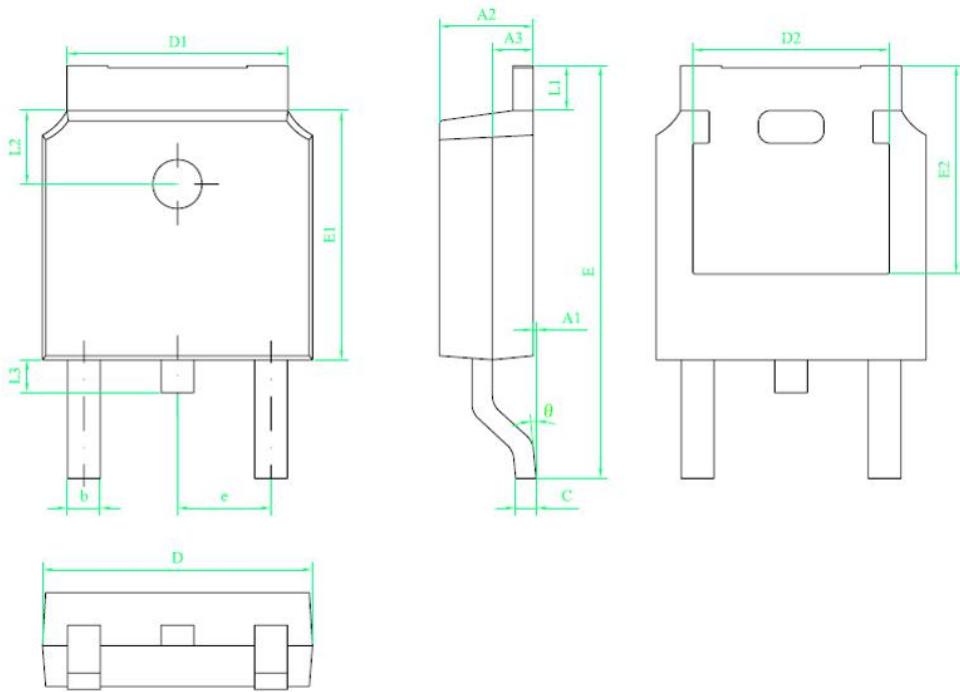


Figure8. Switching wave



## ■ TO-252 Package information



符 号	尺 寸		
	min	nom	max
A1	0	---	0.10
A2	2.20	2.30	2.40
A3	0.90	1.00	1.10
b	0.75	---	0.85
c	0.50	---	0.60
D	6.50	6.60	6.70
D1	5.30	5.40	5.50
D2	4.70	4.80	4.90
E	9.90	10.10	10.30
E1	6.00	6.10	6.20
E2	5.20	5.30	5.40
e	2.20	2.286	2.40
L1	0.90	---	1.25
L2	1.70	1.80	1.90
L3	0.60	0.80	1.00
θ	0°	---	8°

## 技术要求:

1. 树脂体不应有崩裂、缺损等缺陷;
2. 树脂上下部X、Y方向偏差不超过0.20;
3. 胶体两端留废胶总和宽度不超过0.50;
4. 所有单位为mm;



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